

COMPLEMENTARY PAIR ENHANCEMENT MODE MOSFET

#### **Product Summary**

Device	BVDSS	Rds(on) max	I <sub>D</sub> Ta = +25°C
N Observal	001/	35mΩ @ V <sub>GS</sub> = 4.5V	4.5A
N-Channel	20V	56mΩ @ V <sub>GS</sub> = 1.8V	3.5A
P-Channel -20V		74mΩ @ V <sub>GS</sub> = -4.5V	-3.1A
		168mΩ @ V <sub>GS</sub> = -1.8V	-2.0A

# **Description and Applications**

This MOSFET is designed to meet the stringent requirements of automotive applications. It is gualified to AEC-Q101, supported by a PPAP and is ideal for use in:

- Motor controls
- **DC-DC** converters
- Power management functions

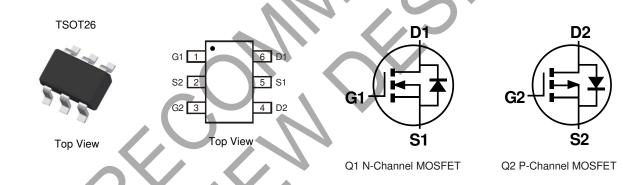
#### **Features and Benefits**

- Low On-Resistance
- Low Input Capacitance
- Fast Switching Speed
- Low Input/Output Leakage
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- The DMC2038LVTQ is suitable for automotive applications requiring specific change control; this part is AEC-Q101 qualified, PPAP capable, and manufactured in IATF 16949 certified facilities.

https://www.diodes.com/guality/product-definitions/

## **Mechanical Data**

- Package: TSOT26
- Package Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals Connections: See Diagram
- Terminals: Finish Matte Tin Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 (c3)
- Weight: 0.013 grams (Approximate)



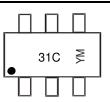
## Ordering Information (Note 4)

Part Number		Package	Packing		
	Fait Number	Fackaye	Qty.	Carrier	
	DMC2038LVTQ-7	TSOT26	3000	Tape & Reel	
Notes:	1. No purposely added lead. Fully I	EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS)	2) & 2015/863/EU (RoHS 3) comp	liant.	

02/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant 2. See https://www.diodes.com/guality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.</p>
4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

# Marking Information



31C = Product Type Marking Code YM = Date Code Marking Y or  $\overline{Y}$  = Year (ex: J = 2022)

M or  $\overline{M}$  = Month (ex: 9 = September)

#### Date Code Key Year 2019 2022 2023 2024 2025 2026 2027 2028 2029 2030 2031 Code G K Μ Ν 0 Ρ R S Sep Oct Nov Dec Month Feb Mar May Jun Jul Aug Jan Apr 8 9 0 Ν D Code 3 5 2 4 6

#### DMC2038LVTQ Document number: DS42188 Rev. 3 - 3

1 of 11 www.diodes.com



# Maximum Ratings N-CHANNEL - Q1 (@TA = +25°C, unless otherwise specified.)

Characteristic			Value	Unit	
Drain-Source Voltage				V	
		Vgss	±12	V	
Steady State	$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	lD	3.7 3.0	А	
t<10s	T <sub>A</sub> = +25°C T <sub>A</sub> = +70°C	ID	4.1 3.2	А	
Steady State	$T_{A} = +25^{\circ}C$ $T_{A} = +70^{\circ}C$	ID	4.5 3.6	А	
t<10s	TA = +25°C TA = +70°C	ID	5.2 4.2	А	
Maximum Continuous Body Diode Forward Current (Note 7)			1.5	А	
Pulsed Drain Current (10μs Pulse, Duty Cycle = 1%)			25	А	
	State t<10s Steady State t<10s nt (Note 7)	$\begin{tabular}{ c c c c } \hline State & T_A = +70^\circ C \\ \hline t < 10s & T_A = +25^\circ C \\ \hline T_A = +70^\circ C \\ \hline Steady & T_A = +25^\circ C \\ \hline State & T_A = +70^\circ C \\ \hline t < 10s & T_A = +25^\circ C \\ \hline T_A = +70^\circ C \\ \hline nt (Note 7) \\ \hline \end{tabular}$	$\begin{tabular}{ c c c c c c c c c c c c c c c c c c c$	$\begin{tabular}{ c c c c c c c c c c c } \hline V_{DSS} & 20 \\ \hline V_{GSS} & \pm 12 \\ \hline Steady & T_A = +25^{\circ}C & & & & & & & & & & & & & & & & & & &$	

# Maximum Ratings P-CHANNEL - Q2 (@TA = +25°C, unless otherwise specified.)

Characteristic			Symbol	Value	Unit
Drain-Source Voltage			VDSS	-20	V
Gate-Source Voltage			VGSS	±12	V
		$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	lo	-2.6 -2.1	A
Continuous Drain Current (Note 5) V <sub>GS</sub> = -4.5V	t<10s	T <sub>A</sub> = +25°C T <sub>A</sub> = +70°C	lD	-2.9 -2.4	A
	Steady State	TA = +25°C TA = +70°C	ID	-3.1 -2.5	A
Continuous Drain Current (Note 6) V <sub>GS</sub> = -4.5V	t<10s	TA = +25°C TA = +70°C	lo	-3.8 -3.0	A
Maximum Continuous Body Diode Forward Current (Note 7)			ls	-1.5	А
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)			Ідм	-17	A

# Thermal Characteristics (@TA = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit
Total Power Dissipation (Note 5)	TA = +25°C	Pp	0.8	w
Total Power Dissipation (Note 3)	$T_A = +70^{\circ}C$	PD	0.5	vv
Thermal Resistance, Junction to Ambient (Note 5)	Steady State	<b>D</b>	168	°C/W
mermai Resistance, sunction to Ambient (Note 5)	t<10s	Reja	120	C/W
Total Power Dissipation (Note 6)	TA = +25°C	PD	1.1	w
Total Power Dissipation (Note 0)	$T_A = +70^{\circ}C$	FD	0.7	vv
Thermal Resistance, Junction to Ambient (Note 6)	Steady State	Dave	114	
mermar Resistance, sunction to Ambient (Note 6)	t<10s	Reja	72	°C/W
Thermal Resistance, Junction to Case (Note 6)		R <sub>eJC</sub>	39	
Operating and Storage Temperature Range		TJ, TSTG	-55 to +150	°C

 Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.
 Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.
 Short duration pulse test used to minimize self-heating effect. Notes:



# Electrical Characteristics Q1 N-CHANNEL (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 7)						
Drain-Source Breakdown Voltage	BVDSS	20	_	—	V	$V_{GS} = 0V, I_{D} = 250 \mu A$
Zero Gate Voltage Drain Current @T <sub>C</sub> = +25°C	IDSS	—	_	1.0	μA	$V_{DS} = 16V, V_{GS} = 0V$
Gate-Source Leakage	lgss	—		±100	nA	$V_{GS} = \pm 12V, V_{DS} = 0V$
ON CHARACTERISTICS (Note 7)						-
Gate Threshold Voltage	V <sub>GS(TH)</sub>	0.4		1.0	V	$V_{DS} = V_{GS}, I_D = 250 \mu A$
		—	27	35		$V_{GS} = 4.5V, I_D = 4.0A$
Static Drain-Source On-Resistance	RDS(ON)	—	33	43	mΩ	VGS = 2.5V, ID = 2.5A
		—	43	56		Vgs = 1.8V, Id = 1.5A
Forward Transfer Admittance	Y <sub>fs</sub>	—	9		S	Vds = 5V, Id = 3.4A
Diode Forward Voltage	VSD	0.4	_	1.1	V	Vgs = 0V, Is = 1A
DYNAMIC CHARACTERISTICS (Note 8)						
Input Capacitance	Ciss	—	400	530	pF	
Output Capacitance	Coss	_	70	90	pF	Vps = 10V, Vgs = 0V, f = 1.0MHz
Reverse Transfer Capacitance	Crss	—	65	100	pF	
Gate Resistance	Rg	—	1.9		Ω	VDS = 0V, VGS = 0V, f = 1MHz
Total Gate Charge (V <sub>GS</sub> = 4.5V)	Qg	_	5.7		nC	
Total Gate Charge (V <sub>GS</sub> = 10V)	Q <sub>g</sub>		12	17	nC	
Gate-Source Charge	Q <sub>gs</sub>	-	0.7		nC	→VDS = 15V, ID = 5.8A
Gate-Drain Charge	Q <sub>gd</sub>		1.4		nC	
Turn-On Delay Time	tD(ON)	-	5	10	ns	
Turn-On Rise Time	tR	—	8	16	ns	V <sub>DS</sub> = 10V, V <sub>GS</sub> = 4.5V,
Turn-Off Delay Time	tD(OFF)	_	25	40	ns	Rg = 6Ω, I <sub>DS</sub> = 1A
Turn-Off Fall Time	tF	+	8	16	ns	7

Notes:7. Short duration pulse test used to minimize self-heating effect.8. Guaranteed by design. Not subject to production testing.





# Electrical Characteristics Q2 P-CHANNEL (@T<sub>A</sub> = +25°C, unless otherwise specified.)

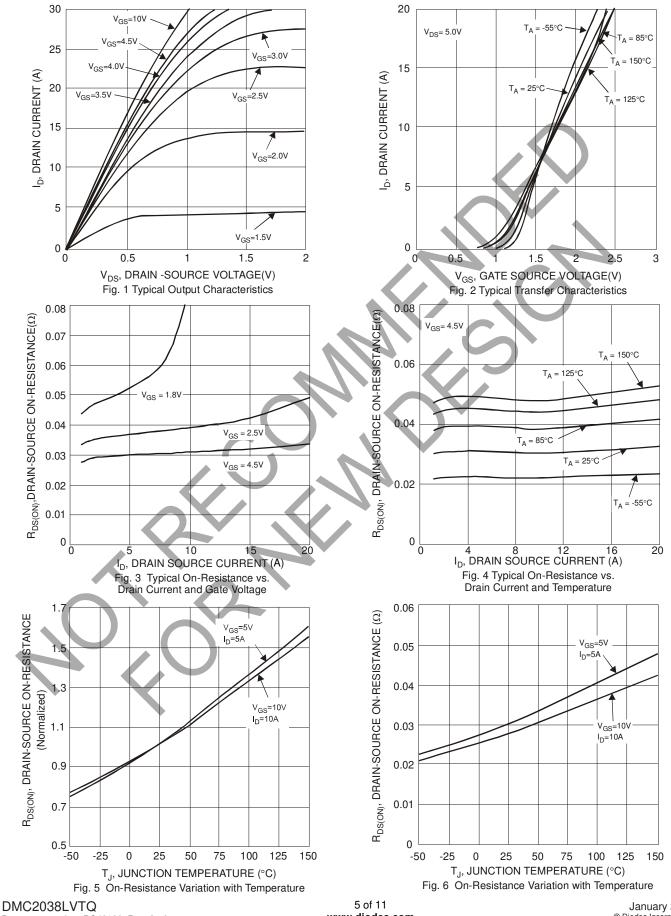
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 7)						
Drain-Source Breakdown Voltage	BVDSS	-20	—	_	V	Vgs = 0V, Id = -250µA
Zero Gate Voltage Drain Current @Tc = +25°C	IDSS		—	-1.0	μA	$V_{DS} = -16V, V_{GS} = 0V$
Gate-Source Leakage	Igss	—	—	±100	nA	$V_{GS} = \pm 12V, V_{DS} = 0V$
ON CHARACTERISTICS (Note 7)						
Gate Threshold Voltage	V <sub>GS(TH)</sub>	-0.4	—	-1.0	V	$V_{DS} = V_{GS}, I_D = -250 \mu A$
			57	74		$V_{GS} = -4.5V, I_D = -3.0A$
Static Drain-Source On-Resistance	RDS(ON)		76	110	mΩ	VGs = -2.5V, I <sub>D</sub> = -1.5A
		_	102	168		Vgs = -1.8V, Id = -1.0A
Forward Transfer Admittance	Y <sub>fs</sub>	_	10	_	S	VDS = -5V, ID = -3.0A
Diode Forward Voltage	Vsd	_	-0.8	-1.0	V	Vgs = 0V, Is = -0.6A
DYNAMIC CHARACTERISTICS (Note 8)						
Input Capacitance	Ciss	_	530	705	pF	
Output Capacitance	Coss	_	70	95	pF	V <sub>DS</sub> = -10V, V <sub>GS</sub> = 0V, f = 1.0MHz
Reverse Transfer Capacitance	Crss		60	90	pF	
Gate Resistance	Rg		72		Ω	$V_{DS} = 0V, V_{GS} = 0V, f = 1MHz$
Total Gate Charge (V <sub>GS</sub> = -4.5V)	Qg	_	7	10	nC	
Total Gate Charge (V <sub>GS</sub> = -10V)	Qg 📢		14		nC	
Gate-Source Charge	Q <sub>gs</sub>	—	0.95		nC	→VDS = -15V, ID = -6A
Gate-Drain Charge	Q <sub>gd</sub>		1.2		nC	7
Turn-On Delay Time	td(on)	+	11	20	ns	
Turn-On Rise Time	tR	<b>—</b>	12	22	ns	V <sub>DS</sub> = -10V, V <sub>GS</sub> = -4.5V,
Turn-Off Delay Time	tD(OFF)	_	21	34	ns	Rg = 6Ω, Is = -1A
Turn-Off Fall Time	tF	+	13	23	ns	

Notes: 7. Short duration pulse test used to minimize self-heating effect. 8. Guaranteed by design. Not subject to production testing.





## **Typical Characteristics - N-CHANNEL**

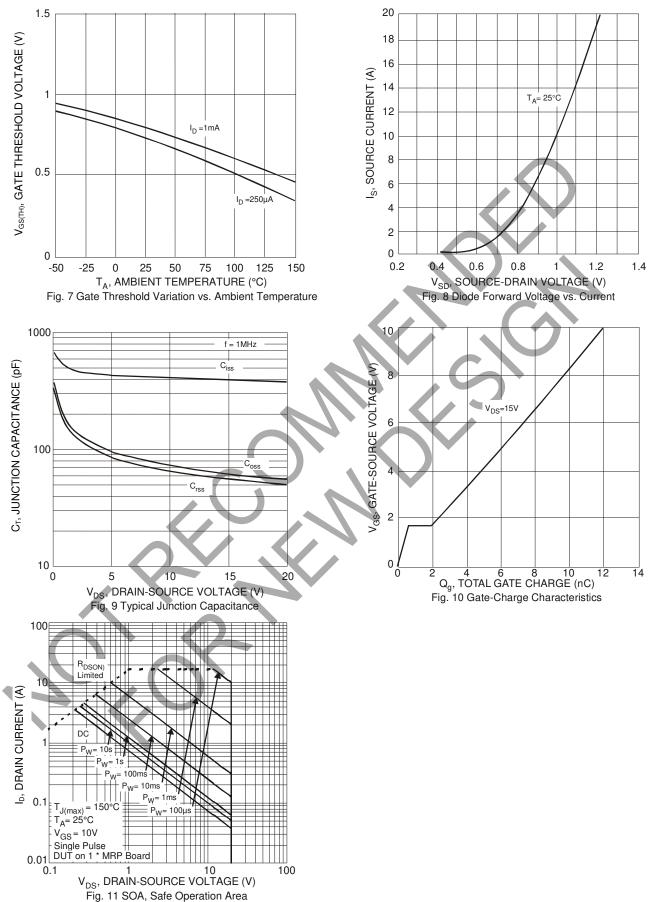


Document number: DS42188 Rev. 3 - 3

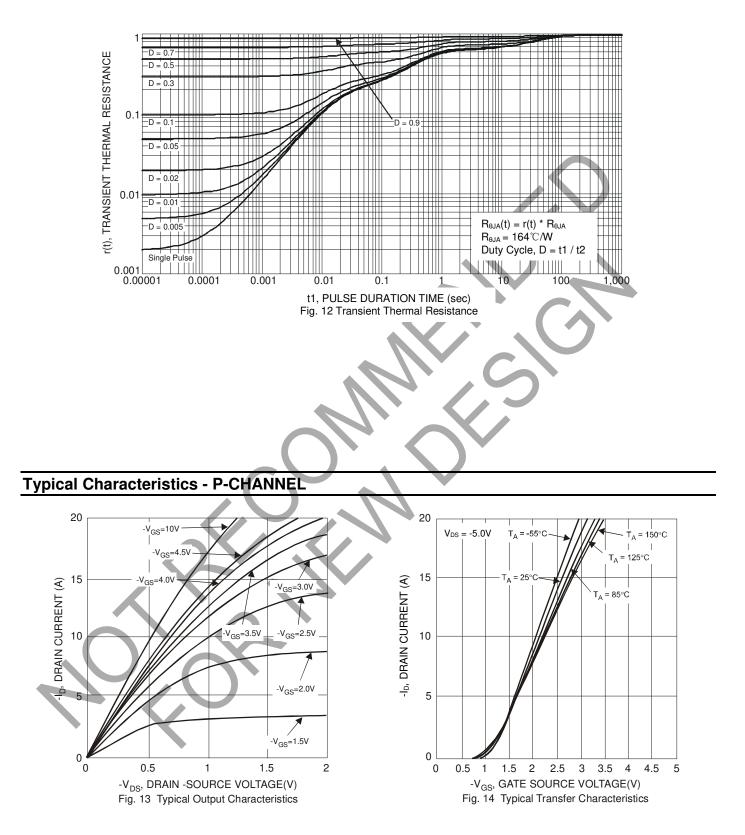
www.diodes.com



# DMC2038LVTQ

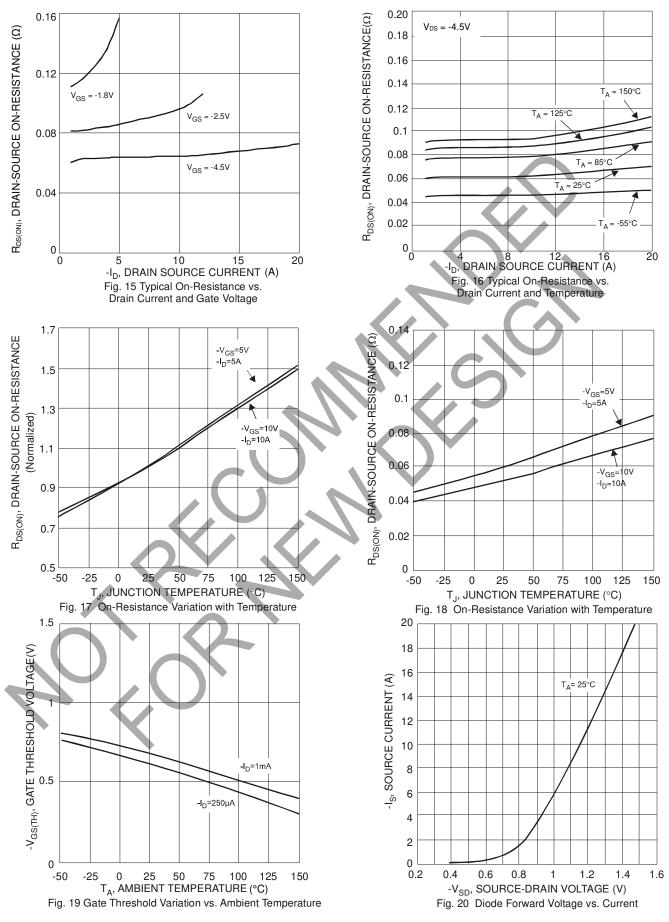






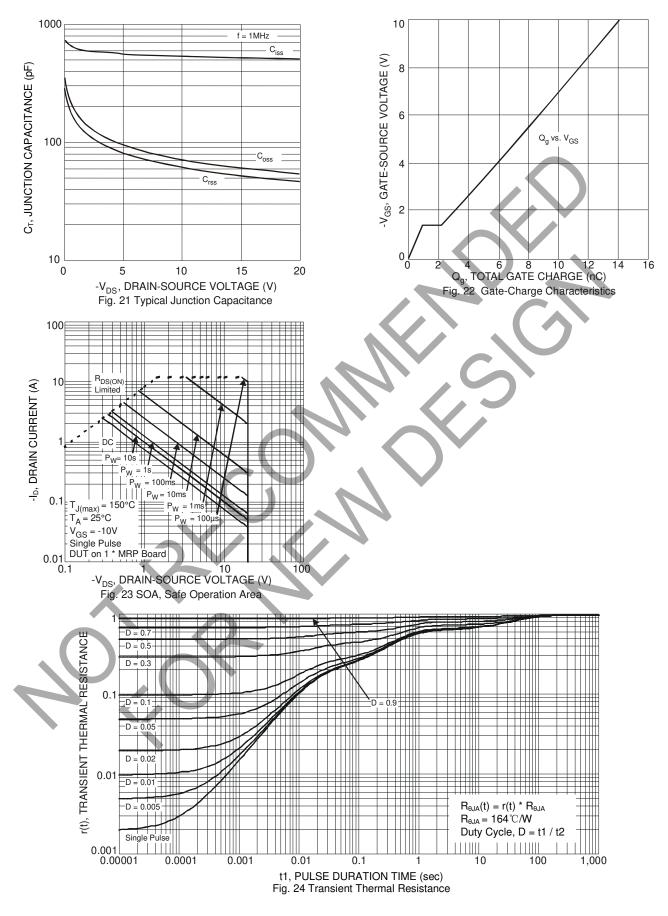


# DMC2038LVTQ





# DMC2038LVTQ

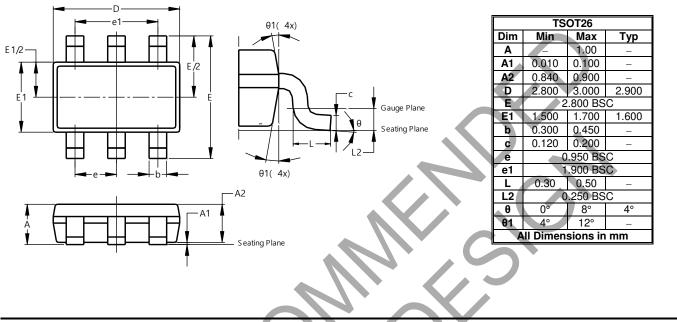




# **Package Outline Dimensions**

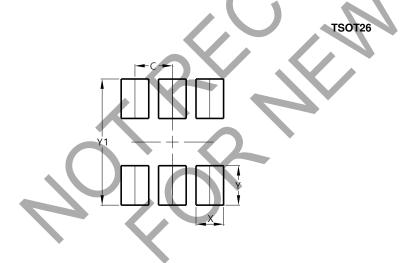
Please see http://www.diodes.com/package-outlines.html for the latest version.

TSOT26



# **Suggested Pad Layout**

Please see http://www.diodes.com/package-outlines.html for the latest version.



Dimensions	Value (in mm)
С	0.950
Х	0.700
Y	1.000
Y1	3.200



#### IMPORTANT NOTICE

1. DIODES INCORPORATED AND ITS SUBSIDIARIES ("DIODES") MAKE NO WARRANTY OF ANY KIND, EXPRESS OR IMPLIED, WITH REGARDS TO ANY INFORMATION CONTAINED IN THIS DOCUMENT, INCLUDING, BUT NOT LIMITED TO, THE IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE OR NON-INFRINGEMENT OF THIRD PARTY INTELLECTUAL PROPERTY RIGHTS (AND THEIR EQUIVALENTS UNDER THE LAWS OF ANY JURISDICTION).

2. The Information contained herein is for informational purpose only and is provided only to illustrate the operation of Diodes products described herein and application examples. Diodes does not assume any liability arising out of the application or use of this document or any product described herein. This document is intended for skilled and technically trained engineering customers and users who design with Diodes products. Diodes products may be used to facilitate safety-related applications; however, in all instances customers and users are responsible for (a) selecting the appropriate Diodes products for their applications, (b) evaluating the suitability of the Diodes products for their intended applications, (c) ensuring their applications, which incorporate Diodes products, comply the applicable legal and regulatory requirements as well as safety and functional-safety related standards, and (d) ensuring they design with appropriate safeguards (including testing, validation, quality control techniques, redundancy, malfunction prevention, and appropriate treatment for aging degradation) to minimize the risks associated with their applications.

3. Diodes assumes no liability for any application-related information, support, assistance or feedback that may be provided by Diodes from time to time. Any customer or user of this document or products described herein will assume all risks and liabilities associated with such use, and will hold Diodes and all companies whose products are represented herein or on Diodes' websites, harmless against all damages and liabilities.

4. Products described herein may be covered by one or more United States, international or foreign patents and pending patent applications. Product names and markings noted herein may also be covered by one or more United States, international or foreign trademarks and trademark applications. Diodes does not convey any license under any of its intellectual property rights or the rights of any third parties (including third parties whose products and services may be described in this document or on Diodes' website) under this document.

Diodes' Standard Terms 5 products provided and Conditions of Sale Diodes are subject to (https://www.diodes.com/about/company/terms-and-conditions/terms-and-conditions-of-sales/) or other applicable terms. This document does not alter or expand the applicable warranties provided by Diodes. Diodes does not warrant or accept any liability whatsoever in respect of any products purchased through unauthorized sales channel.

6. Diodes products and technology may not be used for or incorporated into any products or systems whose manufacture, use or sale is prohibited under any applicable laws and regulations. Should customers or users use Diodes products in contravention of any applicable laws or regulations, or for any unintended or unauthorized application, customers and users will (a) be solely responsible for any damages, losses or penalties arising in connection therewith or as a result thereof, and (b) indemnify and hold Diodes and its representatives and agents harmless against any and all claims, damages, expenses, and attorney fees arising out of, directly or indirectly, any claim relating to any noncompliance with the applicable laws and regulations, as well as any unintended or unauthorized application.

7. While efforts have been made to ensure the information contained in this document is accurate, complete and current, it may contain technical inaccuracies, omissions and typographical errors. Diodes does not warrant that information contained in this document is error-free and Diodes is under no obligation to update or otherwise correct this information. Notwithstanding the foregoing, Diodes reserves the right to make modifications, enhancements, improvements, corrections or other changes without further notice to this document and any product described herein. This document is written in English but may be translated into multiple languages for reference. Only the English version of this document is the final and determinative format released by Diodes.

8. Any unauthorized copying, modification, distribution, transmission, display or other use of this document (or any portion hereof) is prohibited. Diodes assumes no responsibility for any losses incurred by the customers or users or any third parties arising from any such unauthorized use.

Copyright © 2022 Diodes Incorporated

www.diodes.com